

JAESANG electronics co., itd

λ	IODEL	TACT SWITCH	DATE	2006.08.07	DSN	CHK	APP
		SPECIFICATION			K.M.S	M. K. J	Aka.
MC	DEL No.	J S T 1101	PAGE	1 OF 4		U	/
1. Gene	mol						
	witch rating	: D	C 12V, 50n	nA			
	peration temp		0℃ ~ 70℃				
		mperature range : -3					
	ppearance and			e drawing page			
1.5 S	tandard condit	ions : Un	less otherv	vise specified, th	e test and me	asurements sł	nall
		b	e carried o	ut as follows :			
		Ambient	temperatur	e ∶5 ~ 35℃			
		Relative	humidity	:45 ~ 85%RH	Ι		
		Air press	sure	: 86 ~ 106kpa	a (860 ~ 1060	mbar)	
		However, if	doubt arise	es on the decisior	n based on the	e measured va	lues
		under the ab	ove-menti	oned conditions,	the following	conditions	
		shall be emp	loyed.				
		Ambient	temperatur	e :20±2℃			
			-	:65±5%RH			
		Air press	sure	: 86 ~ 106kpa	$a (860 \sim 1060)$	mbar)	
	ormance						
2.1 E	lectrical chara	cteristics					
NO.	ITEMS		TEST C	ONDITIONS		PERFOR	RMANCE
		Applying a stati	c load twic	e the actuating fo	orce to the		
2.1.1	Contact	center of the ste	em, measur	ements shall be i	made with	100ms	2 Max.
	Resistance	a 1kHz small-cu	urrent conta	act resistance me	eter.		
	Insulation	Measurements	shall be ma	de following appl	ication of		
2.1.2	Resistance			cerminals and acr		100MS	2 Min.
	1001010100	and frame for e		and der		100101	

110.	11EWG	TEST CONDITIONS	I ERFORMANCE
2.1.1	Contact Resistance	Applying a static load twice the actuating force to the center of the stem, measurements shall be made with a 1kHz small-current contact resistance meter.	100mΩ Max.
2.1.2	Insulation Resistance	Measurements shall be made following application of DC 100V potential across terminals and across terminals and frame for one minute.	100MΩ Min.
2.1.3	Dielectric Withstanding Voltage	AC 250V (50Hz or 60Hz) shall be applied across terminals and across terminals and frame for one minute.	There shall be no breakdown
2.1.4	Bounce	Lightly striking the center of the stem at a rate encountered in normal use (3 to 4 operation per sec.) bounce shall be tested at 'ON' and 'OFF' $5V = 5k\Omega + 5k\Omega $	10msec Max.

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2.2	2.2 Mechanical characteristics								
NO.	ITEMS		TEST CO	ONDITIONS		PERFOR	RMANCE		
2.2.1	Operation For	↑	Push by recommended operating condition Force Push force Return force Travel						
2.2.2.	Travel		Push by recommended operating condition F = (Operation force) × 2				0.25 ±0.1 mm		
2.2.3	3 Stop Strength A static load of 3kgf shall be applied in the stem operation for a period of 60 seconds				direction of	No damage (Electrical and Mechanical)			
2.2.4	Vibration Te	(2) Sweep rate(3) Sweep method(4) Vibration dir	 (1) Amplitude : 1.5mm (2) Sweep rate : 10-55-10Hz for 1 minute. (3) Sweep method : Logarithmic frequency sweep rate. (4) Vibration direction : X.Y.Z (3 directions). (5) Time : Each direction 2 hours (Total 6 hours). 				No. 2.1 and 2.2.1 to 2.2.2 shall be satisfied.		
2.2.5	Impact Shock T	(2) Cycles of tes	 (1) Acceleration : 80G (2) Cycles of test : 3 cycles each in 6 directions for a total 18 cycles. 				No. 2.1 and 2.2.1 to 2.2.2 shall be satisfied.		
2.2.6	Soldering heat	test (P.W.B : t = Soldering tempe	Soldering area : t/2 of P.W.B thickness (P.W.B : t = 1.6) Soldering temperature : 260±5℃ Soldering time : 5±1 sec				No damage (Electrical and Mechanical)		

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2.3	2.3 Climatic characteristics								
NO.	ITEMS		TEST CO	ONDITIONS		PERFOR	RMANCE		
2.3.1	Cold test	(2) Duration of t (3) Take off a di	 (1) Temperature : -30±2℃ (2) Duration of test : 96 hours (3) Take off a drop water (4) Standard conditions after test : 1 hour 			Contact Resistance : 200mΩ max. No. 2.1.2 to 2.1.4 & 2.2.1 to 2.2.2 shall be satisfied.			
2.3.2	Heat test	(2) Duration of t	 (1) Temperature : 80±2℃ (2) Duration of test : 96 hours (3) Standard conditions after test : 1 hour 			Contact Resistance : 200mΩ max. No. 2.1.2 to 2.1.4 & 2.2.1 to 2.2.2 shall be satisfied.			
2.3.3	Temperature C	(2) Standard cor (3) 1 cycle 60°C -10°C	e 60°C				Contact Resistance : 200mΩ max. No. 2.1.2 to 2.1.4 & 2.2.1 to 2.2.2 shall be satisfied.		
2.3.4	 (1) Temperature : 60±2℃ (2) Relative humidity : 90 ~ 95% (3) Duration of test : 96 hours (4) Take off a drop water (5) Standard conditions after test : 1 hour 			Contact Resistance : 200mΩ max. No. 2.1.2 to 2.1.4 & 2.2.1 to 2.2.2 shall be satisfied.					
2.3.5	Operating Life 7	(2) Operation sp(3) Push force 	 (1) DC 5V, 5mA Resistance load (2) Operation speed : 2 ~ 3 cycles/sec (3) Push force : Maximum value of operation force (4) Cycles of operation : See outside drawing page 			Contact Resistance : 200mΩ max. Bounce : 20m sec max. Operating force : initial value ±30% No. 2.1.2 to 2.1.3 & 2.2.2 shall be satisfied.			
2.3.6	Switch shall be checked after following test. (1) Temperature : 35 ± 2 °C (2) Salt solution : 5 ± 1 % (3) Duration of test : 48 hours				Without excessive rust or discoloration				

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3. Soldering

3.1 Auto soldering conditions

ITEM	CONDITION
Preheat temperature	110°C max. (Environmental temperature of soldering surface of P.W.B)
Preheat time	60 sec max.
Area of flux	1/2 max. of P.W.B thickness
Temperature of solder	255℃ max.
Time of immersion	Within 5 sec
Soldering number	Within 2 time (But should bring down heat of the first soldering)
Printed wiring board	Single sided copper-clad laminates.

1) After switches were soldered, please be careful not to clean switches with solvent.

2) In the case of using soldering iron, soldering conditions shall be 280°C max. and 3 sec max.

3) After switches were soldered, please be careful not to load the knobs of switchs.

3.2 Manual soldering conditions

Temperature : 350 ± 5℃

Time : 3 sec max.